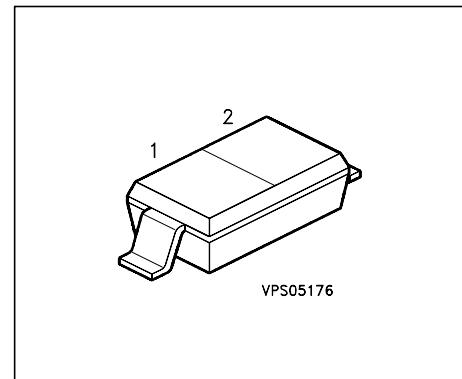


**Silicon Schottky Diode****Preliminary data**

- Rectifier Schottky diode with extreme low  $V_F$  drop for mobile communication
- For power supply
- For clamping and protection in low voltage applications
- For detection and step-up-conversion

**ESD: ElectroStatic Discharge sensitive device, observe handling precautions!**

Type	Marking	Ordering Code	Pin Configuration			Package
BAT 60A	white/3	Q62702-A1188	1 = C	2 = A		SOD-323

**Maximum Ratings**

Parameter	Symbol	Values	Unit
Diode reverse voltage	$V_R$	10	V
Forward current	$I_F$	3	A
Surge forward current ( $t \leq 10\text{ms}$ )	$I_{FSM}$	5	
Total power dissipation	$P_{tot}$		mW
$T_S = 28^\circ\text{C}$		1350	
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	- 55 ... + 150	

**Thermal Resistance**

Junction - ambient 1)	$R_{thJA}$	$\leq 160$	K/W
Junction - soldering point	$R_{thJS}$	$\leq 90$	

1) Package mounted on epoxy pcb 40mm x 40mm x 1.5mm / 6cm<sup>2</sup> Cu

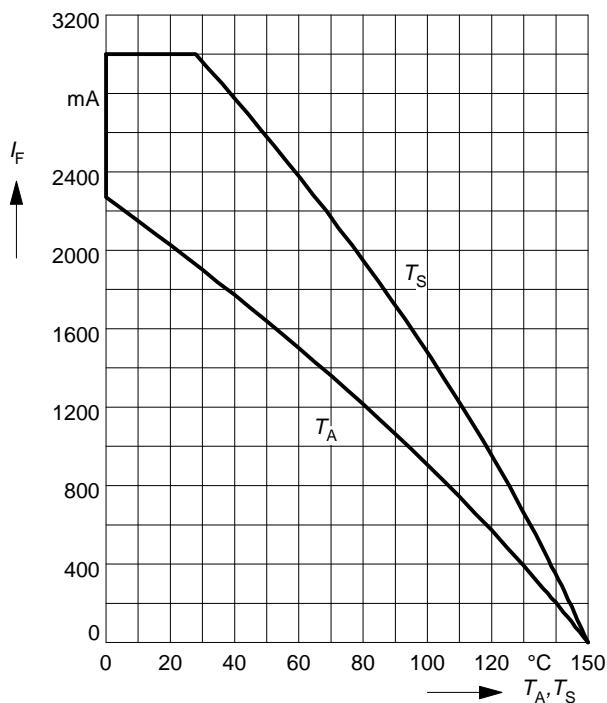
**Electrical Characteristics** at  $T_A=25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>DC characteristics</b>					
Reverse current $V_R = 5 \text{ V}, T_A = 25^\circ\text{C}$	$I_R$	-	0.3	-	mA
$V_R = 8 \text{ V}, T_A = 25^\circ\text{C}$		-	0.45	-	
$V_R = 8 \text{ V}, T_A = 80^\circ\text{C}$		-	18	-	
Forward voltage $I_F = 10 \text{ mA}$	$V_F$	-	0.14	-	V
$I_F = 100 \text{ mA}$		-	0.2	-	
$I_F = 1000 \text{ mA}$		-	0.3	-	
<b>AC Characteristics</b>					
Diode capacitance $V_R = 5 \text{ V}, f = 1 \text{ MHz}$	$C_T$	-	20	-	pF

**Forward current**  $I_F = f(T_A^*; T_S)$

\*): mounted on epoxy PCB

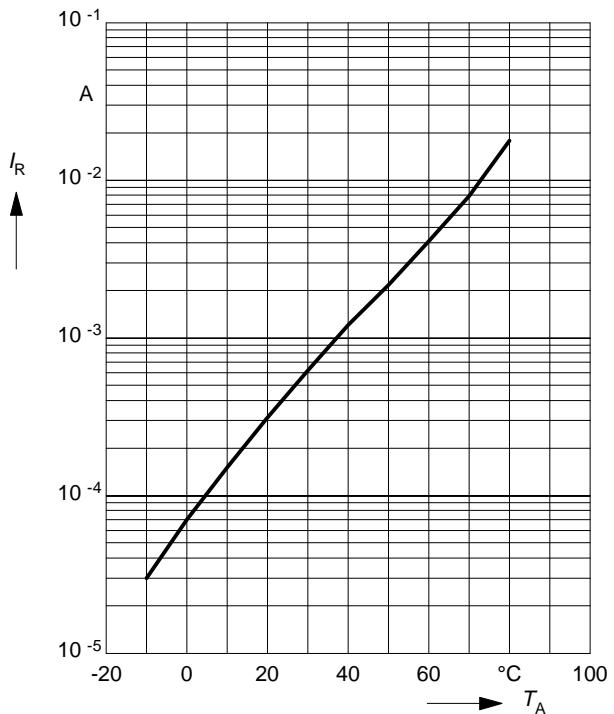
40mm x 40mm x 1.5mm/ 6cm<sup>2</sup> Cu



**Permissible Pulse Load**  $R_{thJS} = f(t_p)$

**Reverse current**  $I_R = f(T_A)$

$V_R = 8V$



**Permissible Pulse Load**  $I_{Fmax}/I_{FDC} = f(t_p)$

